# VSMY14940



Vishay Semiconductors

## High Speed Infrared Emitting Diodes, 940 nm, Surface Emitter Technology



#### DESCRIPTION

As part of the <u>SurfLight</u><sup>TM</sup> portfolio, the VSMY14940 is an infrared, 940 nm, side looking emitting diode based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted PCB based package (with lens) for surface mounting (SMD).

#### APPLICATIONS

- Emitter for remote control
- IR touch panels
- Photointerrupters
- Optical switch

FEATURES
----------

- Package type: surface mount
- Package form: side view
- Dimensions (L x W x H in mm): 3.2 x 2.51 x 1.2
- Peak wavelength:  $\lambda_p = 940 \text{ nm}$
- High reliability
- · High radiant power
- · Very high radiant intensity
- Angle of half intensity:  $\phi = \pm 9^{\circ}$
- Suitable for high pulse current operation
- Floor life: 168 h, MSL 3, according to J-STD-020
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

PRODUCT SUMMA	RY			
COMPONENT	l <sub>e</sub> (mW/sr)	φ (deg)	λ <sub>p</sub> (nm)	t <sub>r</sub> (ns)
VSMY14940	82	± 9	940	10

Note

• Test condition see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE PACKAGING		REMARKS	PACKAGE FORM	
VSMY14940	Tape and reel	MOQ: 1500 pcs, 1500 pcs/reel	Side view	

#### Note

• MOQ: minimum order quantity

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V <sub>R</sub>	5	V	
Forward current		I <sub>F</sub>	70	mA	
Surge forward current	t <sub>p</sub> = 100 μs	I <sub>FSM</sub>	1	А	
Power dissipation		Pv	119	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T <sub>amb</sub>	-40 to +85	°C	
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C	
Soldering temperature	According fig. 10, J-STD-020	T <sub>sd</sub>	260	°C	
Thermal resistance junction / ambient	J-STD-051, soldered on PCB	R <sub>thJA</sub>	390	K/W	

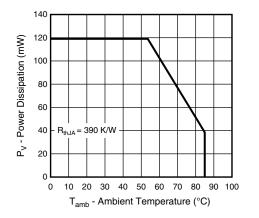
Rev. 1.4, 19-Nov-15

1 For technical questions, contact: <u>emittertechsupport@vishay.com</u> Document Number: 84209

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

(e3) RoHS COMPLIANT HALOGEN

GREEN (5-2008)



www.vishay.com

Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

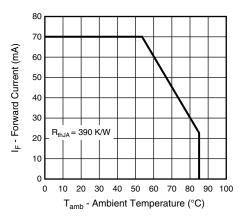
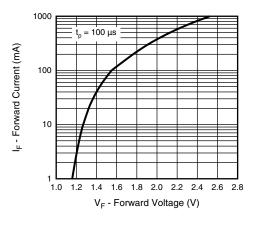


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	V <sub>F</sub>	1.1	1.32	1.6	V
	I <sub>F</sub> = 70 mA, t <sub>p</sub> = 20 ms	V <sub>F</sub>	-	1.48	1.7	V
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	V <sub>F</sub>	-	2.5	-	V
Temperature coefficient of V <sub>F</sub> I <sub>F</sub> = 20 mA		TK <sub>VF</sub>	-	-1.7	-	mV/K
Reverse current		I <sub>R</sub>	not designed for reverse operation		μA	
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ	-	5	-	pF
Radiant intensity	I <sub>F</sub> = 20 mA, t <sub>p</sub> = 20 ms	l <sub>e</sub>	15	24	35	mW/sr
	I <sub>F</sub> = 70 mA, t <sub>p</sub> = 20 ms	l <sub>e</sub>	50	82	120	mW/sr
	I <sub>F</sub> = 1 A, t <sub>p</sub> = 100 μs	l <sub>e</sub>	-	660	-	mW/sr
Radiant power	I <sub>F</sub> = 70 mA, t <sub>p</sub> = 20 ms	фе	-	40	-	mW
Temperature coefficient of radiant power	I <sub>F</sub> = 20 mA	$TK\phi_{e}$	-	-0.21	-	%/K
Angle of half intensity		φ	-	± 9	-	deg
Peak wavelength	I <sub>F</sub> = 20 mA	λp	920	940	960	nm
Spectral bandwidth	I <sub>F</sub> = 20 mA	Δλ	-	35	-	nm
Temperature coefficient of $\lambda_p$	I <sub>F</sub> = 20 mA	ΤKλp	-	0.25	-	nm/K
Rise time	I <sub>F</sub> = 100 mA, 20 % to 80 %	tr	-	10	-	ns
Fall time	I <sub>E</sub> = 100 mA, 20 % to 80 %	t <sub>f</sub>	-	10	-	ns

#### **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)





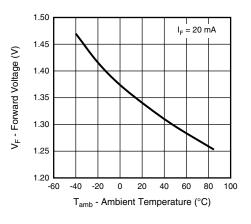


Fig. 4 - Forward Voltage vs. Ambient Temperature

Rev. 1.4, 19-Nov-15

2 suestions contact: emittertechsuppor Document Number: 84209

For technical questions, contact: <u>emittertechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



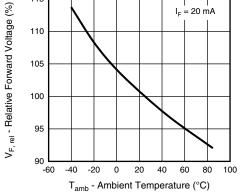


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

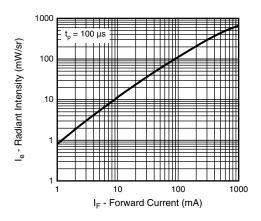


Fig. 6 - Radiant Intensity vs. Forward Current

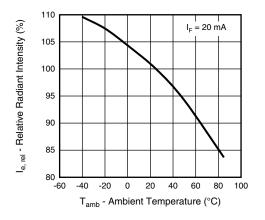


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

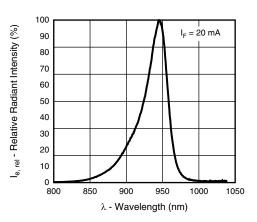


Fig. 8 - Relative Radiant Intensity vs. Wavelength

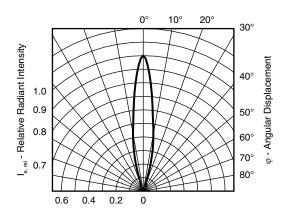
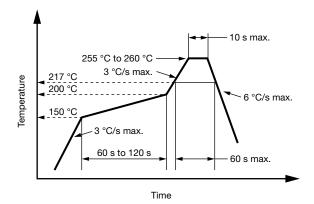


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

For technical questions, contact: <u>emittertechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

#### SOLDER PROFILE

SHA



www.vishay.com

Fig. 10 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

#### PACKAGE DIMENSIONS in millimeters: VSMY14940

#### DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

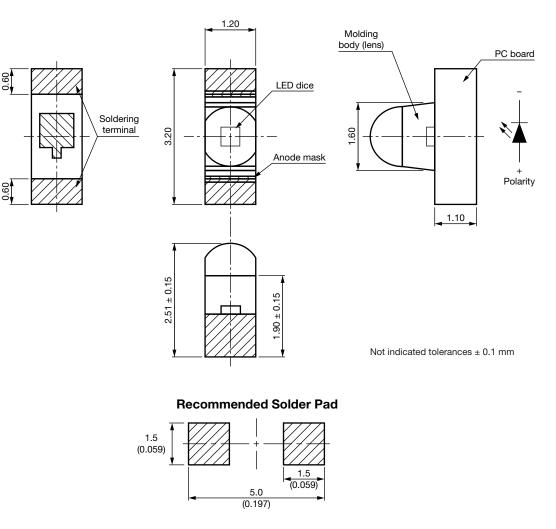
Floor life: 168 h

Conditions: T<sub>amb</sub> < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020.

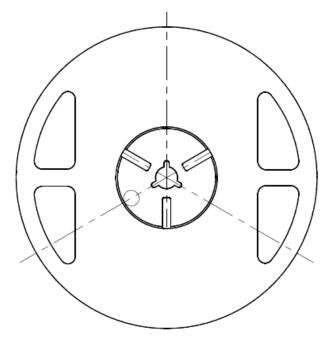
#### DRYING

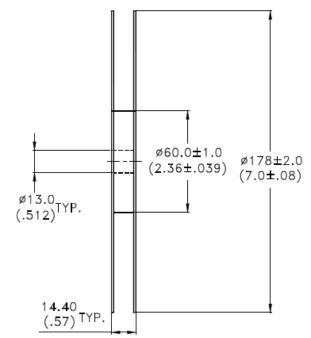
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

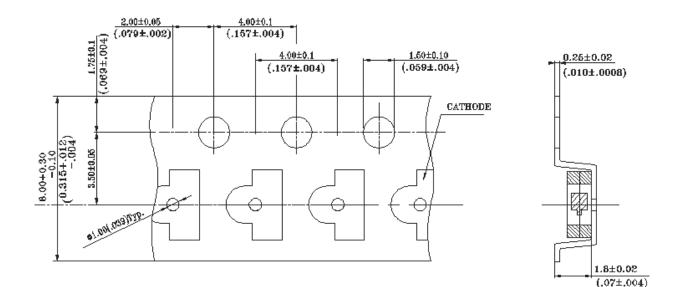




#### TAPING AND REEL DIMENSIONS in millimeters: VSMY14940









Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.